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APPLICATION NO.	FILING DATE		FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.	
10/749,643	12/31/2003		Himanshu Pokharna	42P17649	9394	
8791	7590	03/15/2005		EXAMINER		
		OFF TAYLOR &	CHERVINSKY	CHERVINSKY, BORIS LEO		
12400 WILSHIRE BOULEVARD SEVENTH FLOOR				ART UNIT	PAPER NUMBER	
		90025-1030		2835	<u> </u>	

DATE MAILED: 03/15/2005

Please find below and/or attached an Office communication concerning this application or proceeding.

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-		Application No.	Applicant(s)	
Office Act	ian Summanı	10/749,643	POKHARNA ET AL.	
Οπίζε Αζί	ion Summary	Examiner	Art Unit	-
		Boris L. Chervinsky	2835	
The MAILING D Period for Reply	OATE of this communication app	ears on the cover sheet with the c	orrespondence address	
THE MAILING DATE - Extensions of time may be a after SIX (6) MONTHS from - If the period for reply specific - If NO period for reply is spec - Failure to reply within the set	OF THIS COMMUNICATION. vailable under the provisions of 37 CFR 1.13 the mailing date of this communication. ed above is less than thirty (30) days, a reply iffied above, the maximum statutory period w to or extended period for reply will, by statute, fice later than three months after the mailing	'IS SET TO EXPIRE 3 MONTH(6(a). In no event, however, may a reply be time within the statutory minimum of thirty (30) day ill apply and will expire SIX (6) MONTHS from cause the application to become ABANDONE date of this communication, even if timely filed	nely filed s will be considered timely. the mailing date of this communication. D (35 U.S.C. § 133).	
Status				
1) Responsive to o	communication(s) filed on 31 De	ecember 2003.		
2a) This action is FI	NAL. 2b)⊠ This	action is non-final.		
3) Since this applic	cation is in condition for allowan	ce except for formal matters, pro	secution as to the ments is	
closed in accord	lance with the practice under E	x parte Quayle, 1935 C.D. 11, 45	53 O.G. 213.	
Disposition of Claims				
4)⊠ Claim(s) <u>1-56</u> is	/are pending in the application.			
4a) Of the above	e claim(s) is/are withdraw	vn from consideration.	•	.:
5) Claim(s)	is/are allowed.			·
6)⊠ Claim(s) <u>1-56</u> is	/are rejected.			•
7) Claim(s)	is/are objected to.			
8) Claim(s)	are subject to restriction and/or	election requirement.	•	
Application Papers				•
9)☐ The specification	is objected to by the Examine	`		•
•	•	re: a)⊠ accepted or b)□ object	ed to by the Examiner.	
- · ·		drawing(s) be held in abeyance. See	· ·	
Replacement drav	wing sheet(s) including the correcti	on is required if the drawing(s) is obj	jected to. See 37 CFR 1.121(d).	
11)☐ The oath or decl	aration is objected to by the Ex	aminer. Note the attached Office	Action or form PTO-152.	
Priority under 35 U.S.C.	8 119			,
		neioritu undos 25 H.C.C. \$ 440(a)	(d) or (6)	
a) ☐ All b) ☐ Son	-	priority under 35 U.S.C. § 119(a)	1-(a) or (1).	
•	copies of the priority documents	s have been received		
		s have been received in Applicati	on No	
		ity documents have been receive		
•	n from the International Bureau	· ·	3 -	•••
·		of the certified copies not receive	ed.	
			•	`.'
Attachment(s)				,
1) Notice of References Cite		4) Interview Summary		
	atent Drawing Review (PTO-948) atement(s) (PTO-1449 or PTO/SB/08)	Paper No(s)/Mail Da 5) Notice of Informal P	ate atent Application (PTO-152)	
Paper No(s)/Mail Date		6) Other:	•	

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DETAILED ACTION

Claim Rejections - 35 USC § 102

1. The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

- (a) the invention was known or used by others in this country, or patented or described in a printed publication in this or a foreign country, before the invention thereof by the applicant for a patent.
- 2. Claims 1, 5, 14, 23, 24, 28, 29, 51, 53, 55, 56 are rejected under 35 U.S.C. 102(a) as being anticipated by Nelson et al.

Nelson discloses a system comprising an integrated circuit (IC) die 105; a folded fin microchannel heat exchanger 120 operatively and thermally coupled to the IC die 105, the folded fin microchannel heat exchanger comprising: a thermal mass having a cavity; a folded fin 660C located within the cavity and welded to the metal portion of the cavity, the folded fin 660C defining, at least in part, a plurality of microchannels 600C within the cavity; and an inlet and an outlet 130A, 130B, wherein the microchannels are fluidly coupled at one end to the inlet and at the other end to the outlet; a pump 340, having an inlet and an outlet fluidly coupled to the inlet of the folded fin microchannel heat exchanger 120, and a heat rejecter 150, having an inlet fluidly coupled to the outlet of the folded fin microchannel heat exchanger and an outlet fluidly coupled to the inlet of the pump, wherein the system employs a working fluid that transfers heat generated by the IC die to the heat rejecter using a two-phase heat exchange mechanism; the working fluid is water. The method steps of claims 51, 53, 55 and 56 are necessitated by the device structure as disclosed by Nelson et al.

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Claim Rejections - 35 USC § 103

- 3. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:
 - (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.
- 4. Claims 2-4, 11, 33, 42, 52, 54 are rejected under 35 U.S.C. 103(a) as being unpatentable over Nelson et al.

Nelson discloses the claimed invention, as shown above, except aluminum or copper, and except specific use in an antenna that is coupled to a network interface. The aluminum or copper are commonly used for heat dissipating fins as good thermal conductivity materials. It would have been obvious to one having ordinary skill in the art at the time the invention was made to use aluminum or copper, since it has been held to be within the general skill of a worker in the art to select a known material on the basis of its suitability for the intended use as a matter of obvious design choice. *In re Leshin*, 125 USPQ 416.

It would have been obvious to one having ordinary skill in the art at the time the invention was made to use the claimed cooling structure for a microprocessor, for an antenna or another heat generating device that needs to be cooled, since it has been held that a recitation with respect to the manner in which a claimed apparatus is intended to be employed does not differentiate the claimed apparatus from a prior art apparatus satisfying the claimed structural limitations. *Ex parte Masham*, 2 USPQ2d 1647 (1987).

- 5. Claims 6-8, 10, 15-17, 19, 25, 26, 30, 31, 35, 36, 38, 43-45, 47 are rejected under 35 U.S.C. 103(a) as being unpatentable over Nelson et al. in view of Dove et al. Nelson discloses the claimed invention, as shown above, except solderable layer made of specific materials such as copper, gold etc. Dove discloses the solder paste disposed on the IC die for attaching the IC die to the heat-dissipating device and use the suitable materials for the solderable layer as to provide sufficient thermal conduction. The solderable layer considered as a thermal interface material. It would have been obvious to one having ordinary skill in the art at the time the invention was made to use the solderable layer as disclosed by Dove et al. in the structure disclosed by Nelson et al. and to use claimed materials since it has been held to be within the general skill of a worker in the art to select a known material on the basis of its suitability for the intended use as a matter of obvious design choice. *In re Leshin*, 125 USPQ 416.
- 6. Claims 27, 32, 54 rejected under 35 U.S.C. 103(a) as being unpatentable over Nelson et al. in view of Kenny, Jr. et al.

Nelson discloses the claimed invention except electro-osmotic pump. Kenny, Jr. discloses the cooling system that employs the electro-osmotic pump. It would have been obvious to one having ordinary skill in the art at the time the invention was made to use the electro-osmotic pump as disclosed by Kenny, Jr. et al. since the device disclosed by Nelson may use any suitable pump required for sufficient cooling (col. 5, lines 56-58).

7. Claims 9, 18, 46 are rejected under 35 U.S.C. 103(a) as being unpatentable over Nelson et al. in view of Kobayashi et al.

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Nelson discloses the claimed invention except a thermal adhesive. Kobayashi discloses the thermal mass 38 coupled to the IC package 22 by the thermal adhesive 36. It would have been obvious to one having ordinary skill in the art at the time the invention was made to use thermal adhesive as disclosed by Kobayashi in the device disclosed by Nelson for optimum heat transfer.

8. Claims 11-13, 20-22, 39-41, 48-50 are rejected under 35 U.S.C. 103(a) as being unpatentable over Nelson et al. in view of Dibene, II et al.

Nelson discloses the claimed invention, as shown above, except flip-bonded chip and fasteners with the standoffs. Dibene discloses the flip-bonded chi and fasteners structure with the standoffs to couple the thermal mass and IC die to the substrate. It would have been obvious to one having ordinary skill in the art at the time the invention was made to use the fastener as disclosed by Dibene for the device disclosed by Nelson for reliable attachment the thermal mass and the IC die to the substrate.

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Boris L. Chervinsky whose telephone number is 571-272-2039. The examiner can normally be reached on 8-5.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Lynn D. Feild can be reached on 571-272-2800 ext. 35. The fax phone number for the organization where this application or proceeding is assigned is 703-872-9306.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for Application/Control Number: 10/749,643

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published applications may be obtained from either Private PAIR or Public PAIR.

Status information for unpublished applications is available through Private PAIR only.

For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

BORIS CHÉRVINSKY PRIMARY EXAMINER

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